

## Electronic Patent Application Fee Transmittal

Application Number:	10618113			
Filing Date:	11-Jul-2003			
Title of Invention:	Wafer-level chip scale package and method for fabricating and using the same			
First Named Inventor/Applicant Name:	Rajeev Joshi			
Filer:	kenneth E. Horton/Jenni Harries			
Attorney Docket Number:	11948.21			

Filed as Large Entity

### **Utility Filing Fees**

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
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Basic Filing:

Pages:

Claims:

Miscellaneous-Filing:

Petition:

Patent-Appeals-and-Interference:

Post-Allowance-and-Post-Issuance:

Extension-of-Time:

Extension - 1 month with \$0 paid	1251	1	120	120
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Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Miscellaneous:</b>				
<b>Total in USD (\$)</b>				<b>120</b>